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Related Part Information				
General Information	eCommerce	Related Part Information		
General Info Sales Info Assembly Subcontractors	Pricing & Availability	• Tooling		

Searchable Features:		Other Properties:	
Brand:	AMP	Insulation Resistance (M•):	10,00
RoHS/ELV Compliance:	Not ELV/RoHS compliant	Contact Resistance (m•):	30
Lead Free Solder Processes:	Wave solder capable to 240°C, Wave solder capable to 265°C		
Product Type:	DIP Socket		
Number of Positions:	8		
Row-to-Row Spacing (mm [in]):	7.62 [0.300]		
Contact Mount:	Thru Hole		
Mount Style:	Vertical		
Centerline (mm [in]):	2.54 [0.100]		
Profile:	Standard		
Frame Style:	Ladder		
Leg Style:	Straight		
Contact Material:	Phosphor Bronze		

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Contact Mating Area Plating:	Tin-Lead
Contact Style:	Stamped + Formed
Mating Contact Type:	Dual Leaf
Height Above PC Board (mm [in]):	5.10 [0.200]
Temperature Range (°C):	-40 - +105
Packaging Method:	Tube
<u>Termination Post Length</u> (mm [in]):	3.00 [0.118]
PCB Mount Angle:	Horizontal

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